

1 Description

The iW1781 is a high performance AC/DC power supply controller for rapid charge that uses digital control technology to build peak-current mode PWM flyback power supplies. The device operates in quasi-resonant mode to provide high efficiency and a number of key built-in protection features. The iW1781 can achieve tight multi-level constant voltage and multi-level constant current regulation without a traditional secondary-feedback circuit. It also eliminates the need for loop compensation components while maintaining stability over all operating conditions.

The iW1781 supports USB Power Delivery (USB PD) and other proprietary rapid charging protocols with secondary-to-primary digital communication handled by secondary-side rapid charge interface circuits, including third party ICs. The iW1781 is optimized to work with Dialog's iW656 USB PD controller and other rapid charge protocol ICs for AC/DC adapters, to achieve fast and smooth voltage transition upon request by mobile devices (MD). When paired with the iW656, the iW1781 eliminates the discrete decoders on the primary side, minimizes the external component count and simplifies system designs. The iW656 can communicate with the iW1781 through one optocoupler for all the necessary rapid charge information including output voltage requests, output current limits, output voltage undershoot and output over-voltage.

The iW1781 also has a product option which offers Dialog's exclusive **SmartGrouping** control to provide a predictable frequency spectrum for mobile devices with highly sensitive touch panels. **SmartGrouping** technology provides two-dimensional control of both the grouping size and grouping frequency with switching events at a fixed frequency inside the group.

Dialog's innovative proprietary technology ensures that power adapters designed with the iW656 and iW1781 can provide multiple levels of output voltage and constant current limit negotiated by MDs. Furthermore, the chipset can achieve <20mW no-load power consumption at 5V/3A output setting and fast dynamic load response in typical AC/DC rapid charge adapter designs.

2 Features

- Support USB PD, optional QC2.0/3.0 and other proprietary rapid charge protocols with secondary-side interface circuits
- Pairs with iW656 to provide optimized USB PD solutions
- Support multi-level V_{BUS} from 3V to 20V in 25mV increments with multi-level current limits
- Proprietary secondary-to-primary digital communication with single optocoupler for all the rapid charge information:
 - » Output voltage request
 - » Output current limit
 - » Output voltage undershoot detection for fast dynamic load response
 - » Over-voltage protection
- Tight multi-level constant-voltage and multi-level constant-current regulation with primary-side feedback and control
- Ultra-low no-load power consumption with lowest system cost (<20mW at 230V_{AC} with typical 5V/3A setting)

- No audible noise over entire operating range
- Proprietary optimized load adaptive maximum constant frequency PWM switching with quasiresonant operation achieves best size, efficiency, and common mode noise
- Multi-mode PWM/PFM control improves efficiency at various load conditions
- Optional SmartGrouping control provides a predictable frequency spectrum for mobile devices with highly sensitive touch panels
- User-configurable 4-level cable drop compensation independent of output voltage
- **EZ-EMI®** design enhances manufacturability
- Built-in single-point fault protections against output short-circuit including soft short and half short, output over-voltage, and output over-current
- SmartDefender™ smart hiccup technology helps address issues of soft shorts in cables and connectors by effectively reducing the average output power at fault conditions without latch
- User-configurable external shutdown control

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3 Applications

 Rapid charge AC/DC power adapter for smart phones, tablets and other MDs equipped with USB PD, direct charge and other protocols

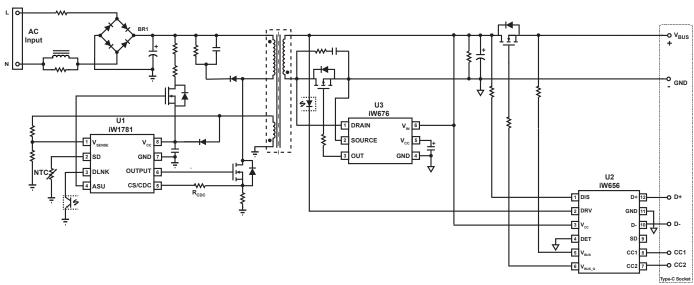


Figure 2.1: iW1781 typical application circuit for standard USB PD with optional QC2.0/QC3.0 enabled (Using iW656 as Secondary-Side Controller for USB PD and iW676 as Synchronous Rectifier Controller.)



4 Pinout Description

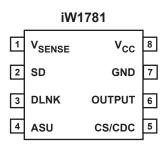


Figure 4.1: 8-Lead SOIC-8 Package

| Pin Number | Pin Name | Туре | Pin Description | | |
|------------|-----------------|--------------|---|--|--|
| 1 | V_{SENSE} | Analog Input | Auxiliary voltage sense. Used for primary-side regulation. | | |
| 2 | SD | Analog Input | External shutdown control. Can be configured for external over-temperature protection (OTP) by connecting an NTC resistor from this pin to Ground. | | |
| 3 | DLNK | Analog Input | Digital communication link signal. Used for secondary-side to primary-side communication for all rapid change information, which includes output voltage requests, output current limits, output voltage undershoot, and over-voltage protection. | | |
| 4 | ASU | Output | Control signal. Used for active start-up device (BJT or depletion mode N-FET). | | |
| 5 | CS/CDC | Analog Input | Primary-side current sense and external cable drop compensation (CDC). Used for cycle-by-cycle peak-current control and limit in primary-side CV/CC regulation. Also used for CDC configuration. | | |
| 6 | OUTPUT | Output | Gate drive for external MOSFET switch. | | |
| 7 | GND | Ground | Ground | | |
| 8 | V _{CC} | Power Input | IC power supply. | | |



5 Absolute Maximum Ratings

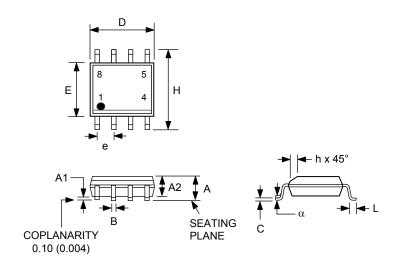
Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded. For maximum safe operating conditions, refer to the Electrical Characteristics section.

| Parameter | Symbol | Value | Units |
|---|------------------|--------------|-------|
| DC supply voltage range (pin 8, I _{CC} = 20mA max) | V _{cc} | -0.3 to 25.0 | V |
| Continuous DC supply current at V _{CC} pin (V _{CC} = 15V) | I _{cc} | 20 | mA |
| ASU output (pin 4) | | -0.3 to 19.0 | V |
| OUTPUT (pin 6) | | -0.3 to 20.0 | V |
| V _{SENSE} input (pin 1, I _{VSENSE} ≤ 10mA) | | -0.7 to 10.0 | V |
| CS/CDC input (pin 5) | | -0.3 to 4.0 | V |
| SD (pin 2) | | -0.3 to 4.0 | V |
| DLNK (pin 3) | | -0.3 to 4.0 | V |
| Maximum junction temperature | T_JMAX | 150 | °C |
| Operating junction temperature | T_JOPT | -40 to 150 | °C |
| Storage temperature | T _{STG} | -65 to 150 | °C |
| Thermal resistance junction-to-ambient | θ_{JA} | 160 | °C/W |
| ESD rating per JEDEC JESD22-A114 | | ±2,000 | V |
| Latch-up test per JESD78D | | ±100 | mA |



6 Physical Dimensions

8-Lead Small Outline (SOIC) Package



| Symbol | Incl | hes | Millimeters | | |
|--------|--------|-------|-------------|------|--|
| Syr | MIN | MAX | MIN | MAX | |
| Α | 0.053 | 0.069 | 1.35 | 1.75 | |
| A1 | 0.0040 | 0.010 | 0.10 | 0.25 | |
| A2 | 0.049 | 0.059 | 1.25 | 1.50 | |
| В | 0.014 | 0.019 | 0.35 | 0.49 | |
| С | 0.007 | 0.010 | 0.19 | 0.25 | |
| D | 0.189 | 0.197 | 4.80 | 5.00 | |
| Ε | 0.150 | 0.157 | 3.80 | 4.00 | |
| е | 0.050 | BSC | 1.27 BSC | | |
| Η | 0.228 | 0.244 | 5.80 | 6.20 | |
| h | 0.10 | 0.020 | 0.25 | 0.50 | |
| L | 0.016 | 0.049 | 0.4 | 1.25 | |
| α | 0° | 8° | | | |

Compliant to JEDEC Standard MS12F

Controlling dimensions are in inches; millimeter dimensions are for reference only

This product is RoHS compliant and Halide free.

Soldering Temperature Resistance:

- [a] Package is IPC/JEDEC Std 020D moisture sensitivity level 1
- [b] Package exceeds JEDEC Std No. 22-A111 for solder immersion resistance; package can withstand 10 s immersion < 260°C

Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25 mm per side.

The package top may be smaller than the package bottom. Dimensions D and E1 are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

7 Ordering Information

| Part Number | Options | | | | | | | |
|----------------|----------------------------|---|---|--------------------------------|---------------------|--|---------|--------------------------|
| | Protocol Supported | Default k _{cc} at Start-up | CC Shutdown Voltage | V _{BUS} Resolution | Latch Conditions | CV Operation Modes | Package | Description |
| iW1781-00 | USB PD and other protocols | 0.263 | 66% of V _{BUS} | 25mV/step | N/A | PWM/PFM | SOIC-8 | Tape & Reel ¹ |
| iW1781-21 | USB PD and other protocols | 0.263 | No CC Operation | 25mV/step | OVP/OTP | PWM/PFM | SOIC-8 | Tape & Reel ¹ |
| iW1781-30 | USB PD and other protocols | 0.263 | $3V$ for $V_{BUS} < 9V$ 6.5V for $9V \le V_{BUS} < 12V$ $10V$ for $V_{BUS} \ge 12V$ | 25mV/step | N/A | PWM/ Smart- Grouping /PFM | SOIC-8 | Tape & Reel¹ |

Note 1: Tape & Reel packing quantity is 2,500/reel. Minimum ordering quantity is 2,500.



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